

Specification GB300 Cold Plate

P/N	GB300 Cold Plate
Platform	GB300
Type	Discrete Accelerator
Architecture	4x Blackwell Ultra GPU + 2x Grace CPU
TDP(W)	1400x4 (GPU) +300x2 (CPU)
Total TDP(W)	6200
Liquid Cooling module Size ( WxDxH )	380 x 430 x 40 mm
Liquid Cooling module Weight(KG)	9.5
Liquid coolant	DI Water/PG25
Quick connector	UQD04
Liquid Tube Material	Stainless steel
Inlet Flow Temperature (°C)	45
Inlet Flow Rate of Liquid (LPM)	GPU:1.7/ CPU:0.7
Liquid pressure drop (PSI)	GPU:2.51/ CPU:2.48



# GB300 Cold Plate

## Key Features

- Cooling capacity : 6200W
- Compatible with DI Water/PG25 coolant
- Suitable for GB300 Superchip server and 2U chassis
- Uses UQD & NVQD connectors and stainless steel corrugated tubing

## Applications



HPC



AI

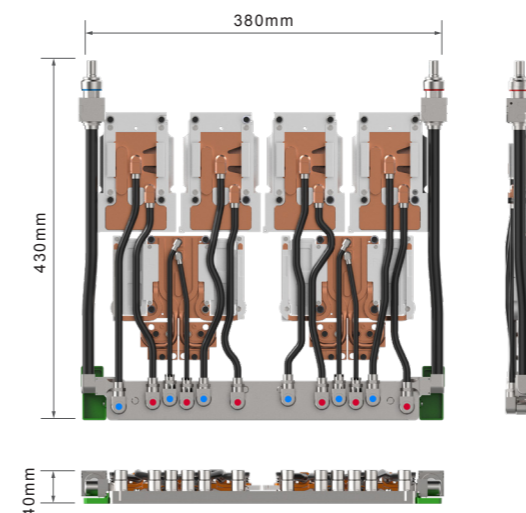


Deep Learning Training



Data Analytics

## Dimension Details



For more product information and sales inquiries :

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